

Electronic Patent Application Fee Transmittal

Application Number:	10750021			
Filing Date:	30-Dec-2003			
Title of Invention:	Method for fabricating semiconductor device having trench type device isolation layer			
First Named Inventor/Applicant Name:	Tae-Woo Jung			
Filer:	Stacie Jo Sundquist/Si Vuong			
Attorney Docket Number:	51876P542			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Claims in excess of 20	1202	5	50	250
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 3 months with \$0 paid	1253	1	1020	1020
Miscellaneous:				
Total in USD (\$)				1270